



# Alfa-MOS Technology

# AFN7434S 40V N-Channel Enhancement Mode MOSFET

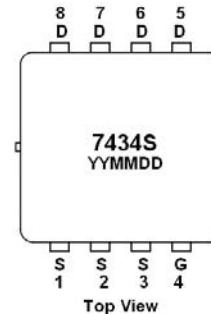
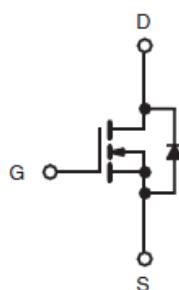
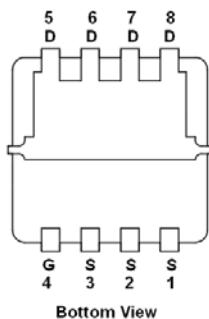
## General Description

AFN7434S, N-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent  $R_{DS(ON)}$ , low gate charge. These devices are particularly suited for low voltage power management, such as smart phone and notebook computer and other battery powered circuits, and low in-line power loss are needed in commercial industrial surface mount applications.

## Features

- 40V/9A, $R_{DS(ON)}= 17m\Omega @ V_{GS}=10V$
- 40V/7A, $R_{DS(ON)}= 24m\Omega @ V_{GS}=4.5V$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- DFN3.3X3.3-8L package design

## Pin Description ( DFN3.3X3.3-8L )



## Application

- DC-DC Converter
- POL

## Pin Define

Pin	Symbol	Description
1	S	Source
2	S	Source
3	S	Source
4	G	Gate
5	D	Drain
6	D	Drain
7	D	Drain
8	D	Drain

## Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFN7434SFN308RG	7434S	DFN3.3X3.3-8L	Tape & Reel	5000 EA

※ YY year code

※ MM month code

※ DD date code

※ AFN7434SFN308RG : 13" Tape & Reel ; Pb-Free ; Halogen-Free



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### Absolute Maximum Ratings

( $T_A=25^\circ\text{C}$  Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	$V_{DSS}$	40	V
Gate –Source Voltage	$V_{GSS}$	$\pm 20$	V
Continuous Drain Current( $T_J=150^\circ\text{C}$ )	$I_D$	10	A
$T_A=70^\circ\text{C}$		8	
Pulsed Drain Current	$I_{DM}$	25	A
Continuous Source Current(Diode Conduction)	$T_A=25^\circ\text{C}$	3	A
Power Dissipation	$P_D$	3.8	W
$T_A=70^\circ\text{C}$		2	
Operating Junction Temperature	$T_J$	150	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55/150	$^\circ\text{C}$
Thermal Resistance-Junction to Ambient	$R_{\theta JA}$	120	$^\circ\text{C}/\text{W}$

### Electrical Characteristics

( $T_A=25^\circ\text{C}$  Unless otherwise noted)

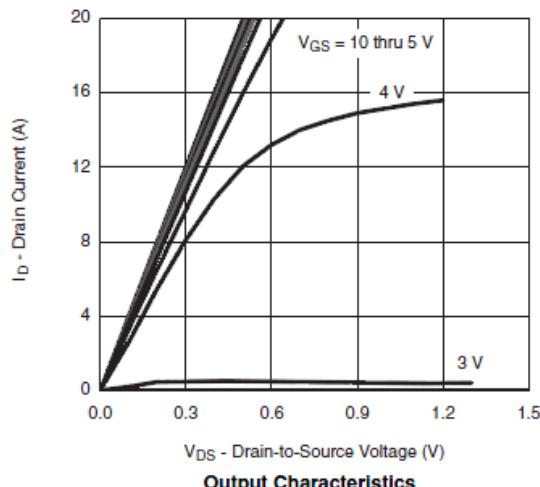
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	40			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1.0		3.0	
Gate Leakage Current	$I_{GSS}$	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=40\text{V}, V_{GS}=0\text{V}$			1	
		$V_{DS}=40\text{V}, V_{GS}=0\text{V}$ $T_J=85^\circ\text{C}$			10	uA
On-State Drain Current	$I_{D(on)}$	$V_{DS}\geq 5\text{V}, V_{GS}=10\text{V}$	20			A
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10\text{V}, I_D=9\text{A}$		13	17	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=7\text{A}$		18	24	
Forward Transconductance	$g_{FS}$	$V_{DS}=15\text{V}, I_D=5.0\text{A}$		25		S
Diode Forward Voltage	$V_{SD}$	$I_S=2\text{A}, V_{GS}=0\text{V}$		0.85	1.2	V
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{DS}=20\text{V}, V_{GS}=4.5\text{V}$ $I_D= 5\text{A}$		10	14	nC
Gate-Source Charge	$Q_{gs}$			2.8		
Gate-Drain Charge	$Q_{gd}$			3.2		
Input Capacitance	$C_{iss}$	$V_{DS}=20\text{V}, V_{GS}=0\text{V}$ $f=1\text{MHz}$		700		pF
Output Capacitance	$C_{oss}$			110		
Reverse Transfer Capacitance	$C_{rss}$			75		
Turn-On Time	$t_{d(on)}$	$V_{DD}=20\text{V}, R_L=4\Omega$ $I_D=5.0\text{A}, V_{GEN}=10\text{V}$ $R_G=1\Omega$		6	12	ns
	$t_r$			10	20	
Turn-Off Time	$t_{d(off)}$			20	36	
	$t_f$			6	12	



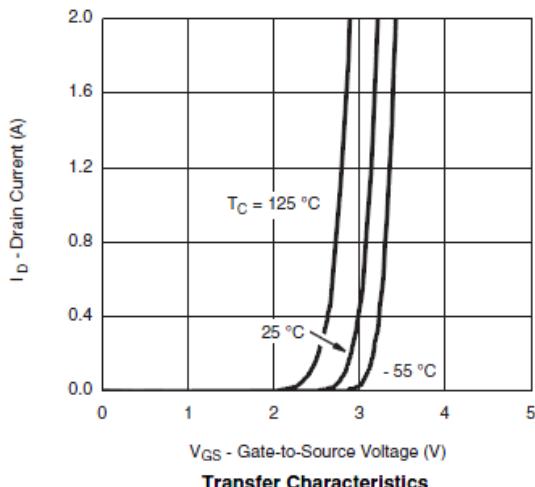
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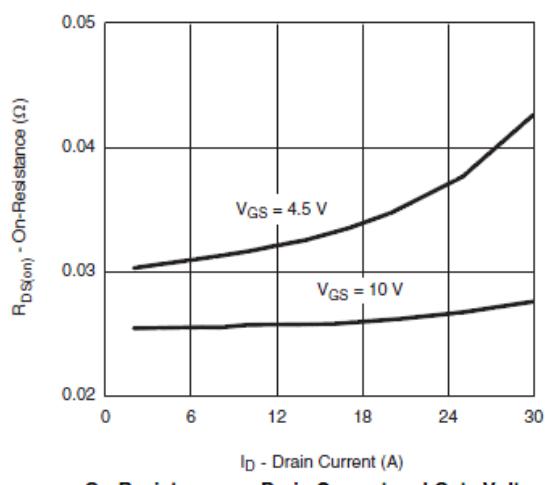
### Typical Characteristics



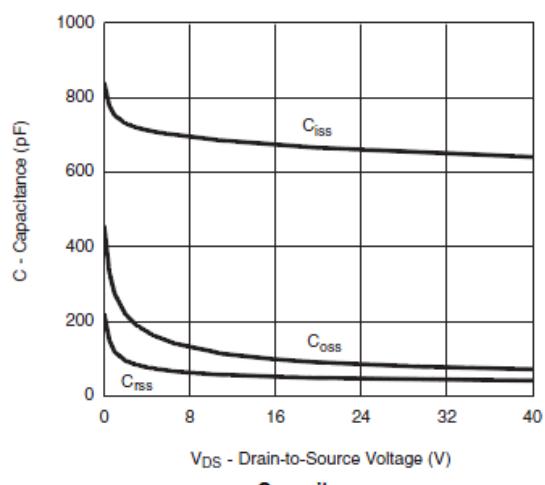
**Output Characteristics**



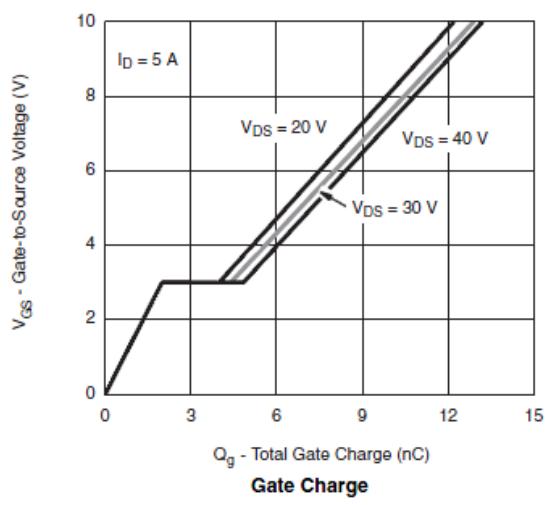
**Transfer Characteristics**



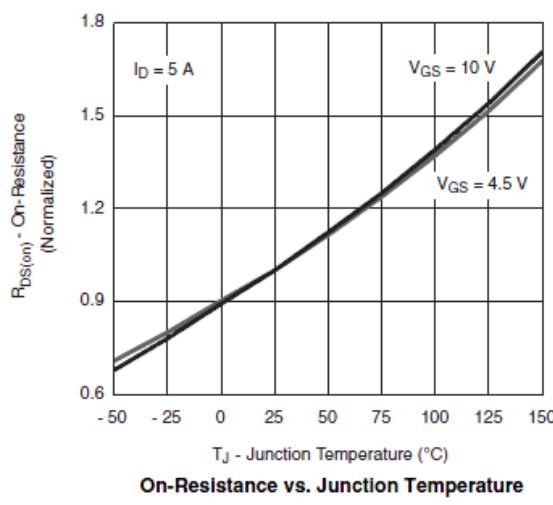
**On-Resistance vs. Drain Current and Gate Voltage**



**Capacitance**



**Gate Charge**



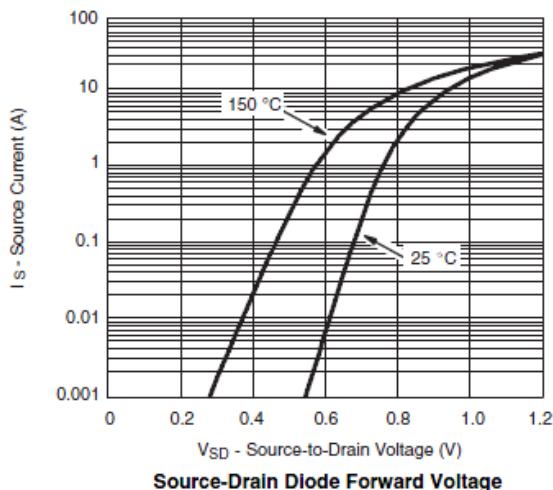
**On-Resistance vs. Junction Temperature**



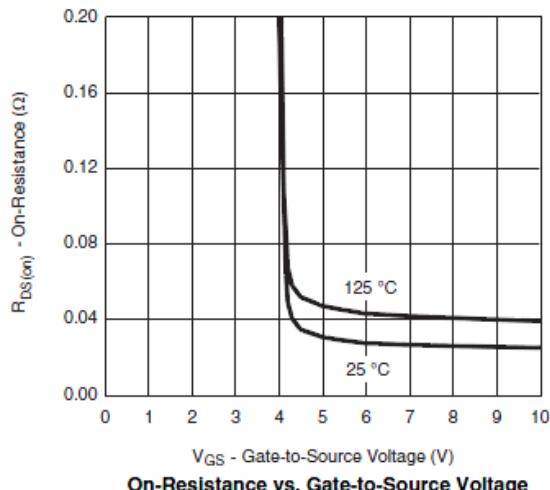
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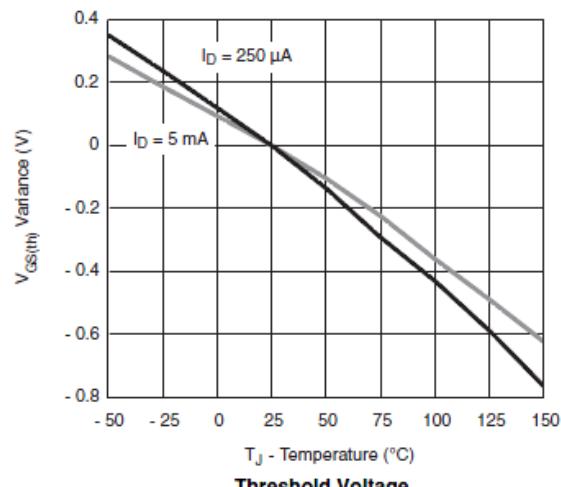
### Typical Characteristics



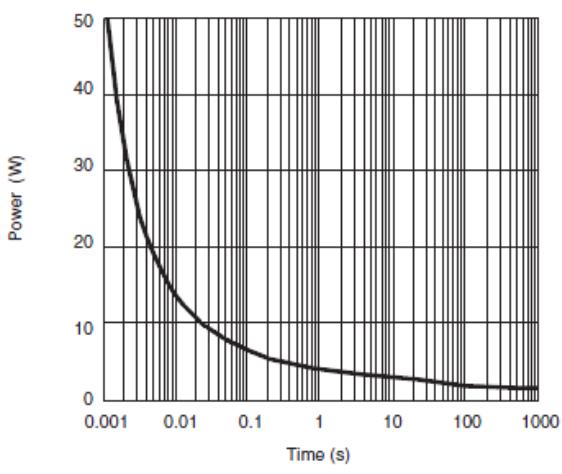
Source-Drain Diode Forward Voltage



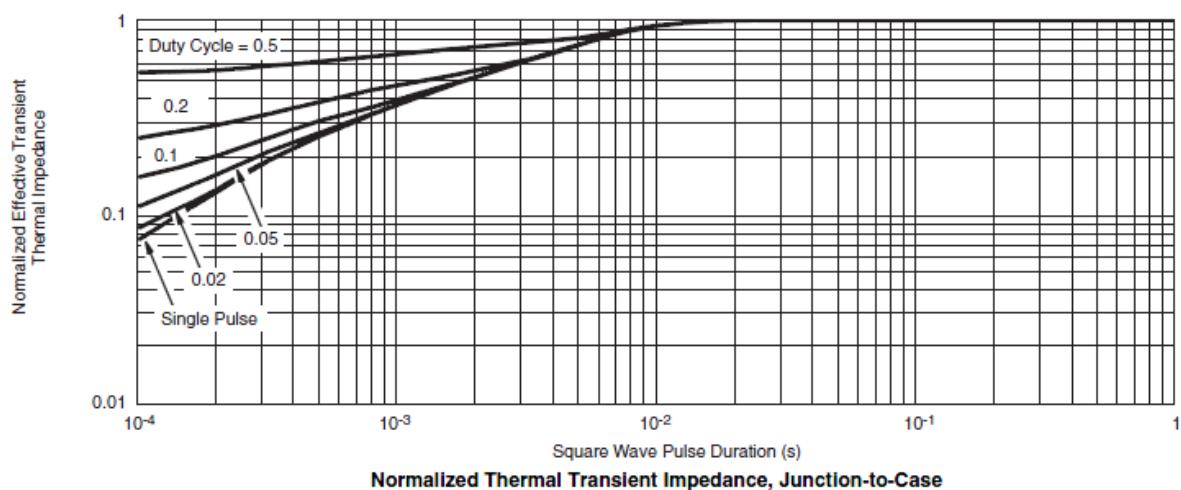
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient

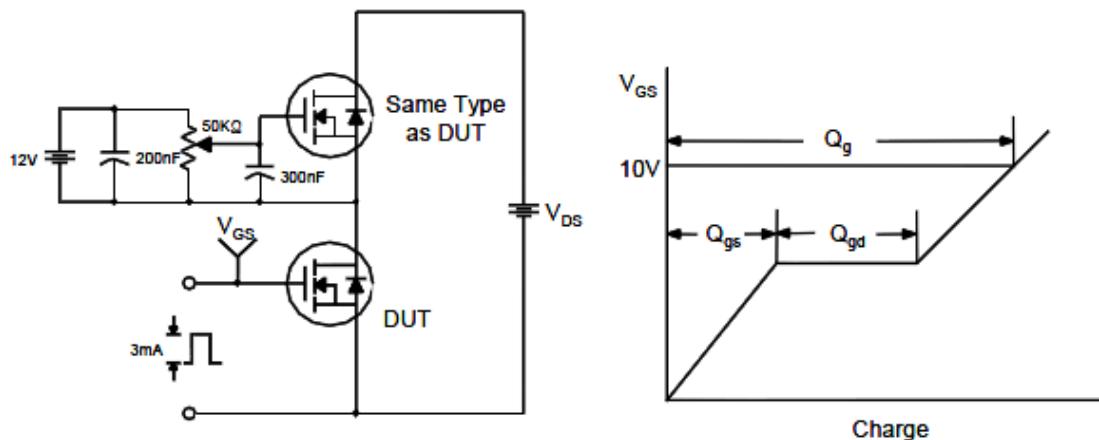


Normalized Thermal Transient Impedance, Junction-to-Case

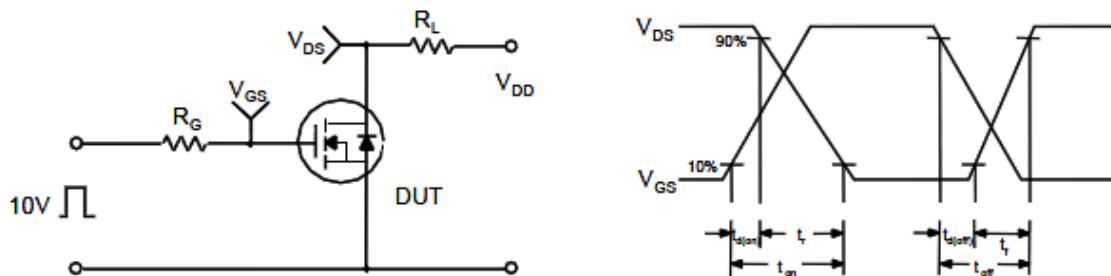


### Typical Characteristics

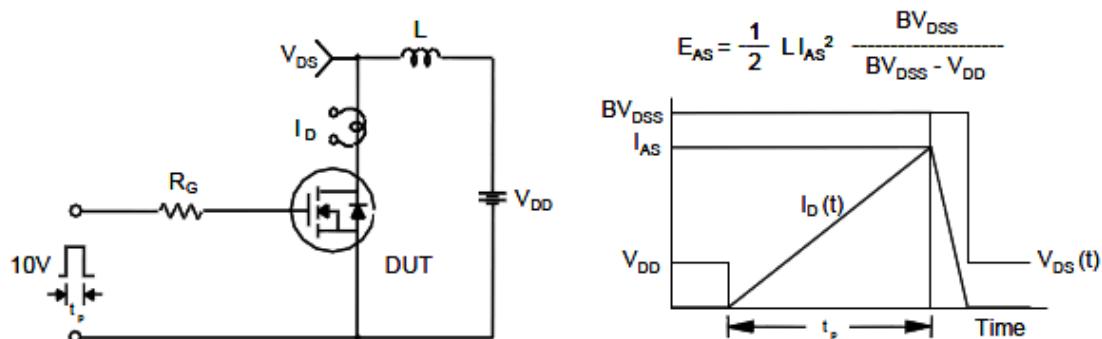
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

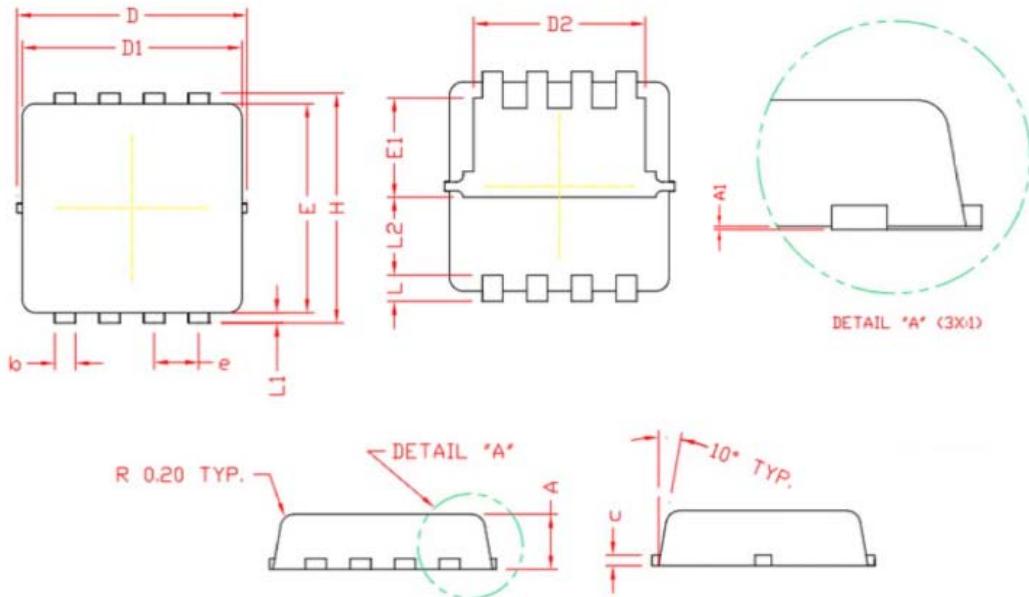




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**COMMON DIMENSIONS**

(UNITS OF MEASURE= MILLIMETER)

SYMBOL	MIN	NOM	MAX
A	0.70	0.80	0.90
A1	0.00	0.03	0.05
b	0.24	0.30	0.35
c	0.10	0.15	0.20
D	3.25	3.32	3.40
D1	3.05	3.15	3.25
D2	2.40	2.50	2.60
E	3.00	3.10	3.20
E1	1.35	1.45	1.55
e		0.65 BSC.	
H	3.20	3.30	3.40
L	0.30	0.40	0.50
L1	0.10	0.15	0.20
L2		1.13 REF.	

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